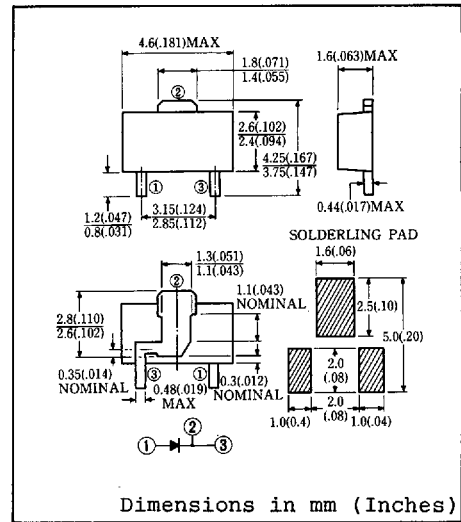


- Similar to TO-243AB (SOT-89) Case
- Surface Mount Device
- Ultra - Fast Recovery
- Low Forward Voltage Drop
- Low Power Loss, High Efficiency
- 100 Volts thru 400 Volts Types Available
- Packaged in 12mm Tape and Reel



Approx. Net Weight : 0.05 Grams

MAXIMUM RATINGS

Voltage Rating	TYPE		Unit		
	Symbol	◆E11FS3		◆E11FS4	
Repetitive Peak Reverse Voltage	V_{RRM}	300	400	V	
Non-Repetitive Peak Reverse Voltage	V_{RSM}	330	440	V	
Electrical Rating	Symbol	Condition		Rating	Unit
Average Rectified Output Current	I_o	180° rectangular wave conduction P.C. Board mounted * $T_a = 13^\circ\text{C}$		1.1	A
		180° sinusoidal wave conduction P.C. Board mounted * $T_a = 25^\circ\text{C}$		1.0	
RMS Forward Current	$I_{F(RMS)}$			1.57	A
Peak One-cycle Forward Surge Current	I_{FSM}	50Hz half sine wqve, non-repetitive		20	A
Operating Junction Temperature Range	T_{jw}			-40 to 150	°C
Storage Temperature Range	T_{stg}			-40 to 150	°C

ELECTRICAL & THERMAL CHARACTERISTICS

Characteristics	Symbol	Test Condition		Max.	Unit
Peak Forward Voltage	V_{FM}	$I_{FM} = 1.0\text{A}$	$T_j = 25^\circ\text{C}$	1.25	V
Peak Reverse Current	I_{RM}	$V_{RM} = V_{RRM}$	$T_j = 25^\circ\text{C}$	20	μA
Reverse Recovery Time	t_{rr}	$I_{FM} = 1\text{A}$	$-di/dt = 50\text{A}/\mu\text{s}$ $T_j = 25^\circ\text{C}$	30	ns
Thermal Resistance	$R_{th(j-a)}$	Junction to Ambient, PCB mounted*		110	°C/W

* P.C. Board Print Land = 15 x 15 mm

◆ For spare parts only

FIG.1-FORWARD VOLTAGE VS. FORWARD CURRENT

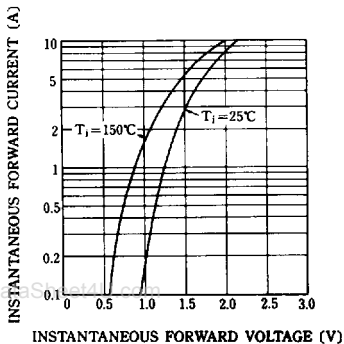


FIG.2-AVERAGE FORWARD POWER DISSIPATION

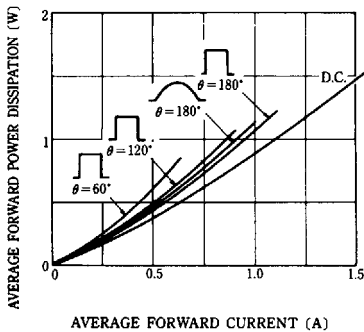


FIG.3-AVERAGE FORWARD CURRENT VS. AMBIENT TEMPERATURE

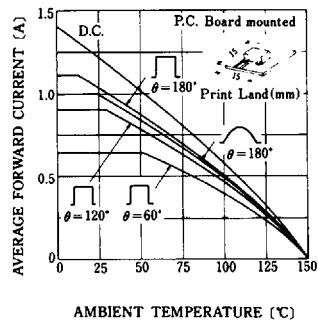


FIG.4-SURGE CURRENT RATINGS

